

Features

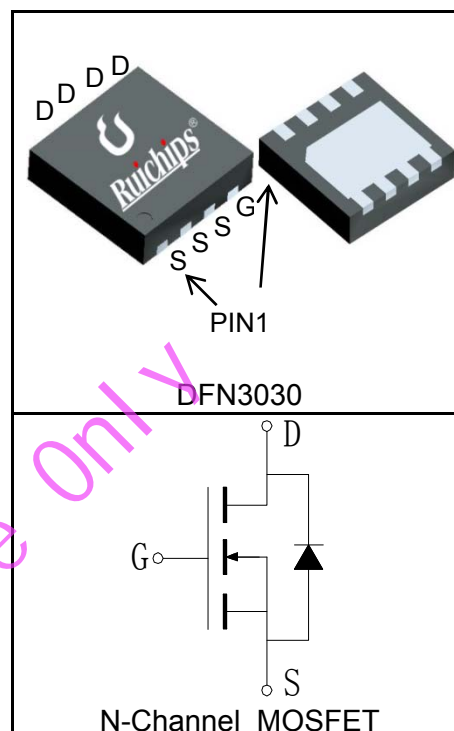
- 40V/40A,
 $R_{DS(ON)} = 5\text{m}\Omega(\text{Typ.})@V_{GS}=10\text{V}$
 $R_{DS(ON)} = 6.5\text{m}\Omega(\text{Typ.})@V_{GS}=4.5\text{V}$
- Ultra Low On-Resistance
- Uses Ruichips advanced RUISGT™ technology
- 100% avalanche tested
- Lead Free and Green Devices Available (RoHS Compliant)



Applications

- DC/DC Converters
- On board power for server
- Synchronous rectification

Pin Description



Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Ratings ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)				
V_{DSS}	Drain-Source Voltage	40	V	
V_{GSS}	Gate-Source Voltage	± 20		
T_J	Maximum Junction Temperature	150	$^\circ\text{C}$	
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$	
I_S	Diode Continuous Forward Current	$T_C=25^\circ\text{C}$	40	A
Mounted on Large Heat Sink				
$I_{DP}^{①}$	300 μs Pulse Drain Current Tested	$T_C=25^\circ\text{C}$	160	A
$I_D^{②}$	Continuous Drain Current@ $T_C(V_{GS}=10\text{V})$	$T_C=25^\circ\text{C}$	40	A
		$T_C=100^\circ\text{C}$	25	
	Continuous Drain Current@ $T_A(V_{GS}=10\text{V})^{③}$	$T_A=25^\circ\text{C}$	18	
		$T_A=70^\circ\text{C}$	14	
P_D	Maximum Power Dissipation@ T_C	$T_C=25^\circ\text{C}$	34	W
		$T_C=100^\circ\text{C}$	13	
	Maximum Power Dissipation@ $T_A^{③}$	$T_A=25^\circ\text{C}$	4.2	
		$T_A=70^\circ\text{C}$	2.7	

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	3.72	°C/W
$R_{\theta JA}$ ③	Thermal Resistance-Junction to Ambient	35	°C/W
Drain-Source Avalanche Ratings			
E_{AS} ④	Avalanche Energy, Single Pulsed	42	mJ

Electrical Characteristics ($T_C=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Condition	RUH4040M2			Unit
			Min.	Typ.	Max.	
Static Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	40			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V$			1	μA
		$T_J=125^\circ C$			30	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	1		2.5	V
I_{GSS}	Gate Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			± 100	nA
$R_{DS(ON)}$ ⑤	Drain-Source On-state Resistance	$V_{GS}=4.5V, I_{DS}=20A$		6.5	9	$m\Omega$
		$V_{GS}=10V, I_{DS}=20A$		5	6.5	$m\Omega$
		$T_J=150^\circ C$		7.9	10.3	$m\Omega$
Diode Characteristics						
V_{SD} ⑤	Diode Forward Voltage	$I_{SD}=40A, V_{GS}=0V$			1.2	V
gfs	Transconductance	$V_{DS}=5V, I_{DS}=40A$		90		S
t_{rr}	Reverse Recovery Time	$I_{SD}=40A, dI_{SD}/dt=100A/\mu s$		16		ns
Q_{rr}	Reverse Recovery Charge			7		nC
Dynamic Characteristics ⑥						
R_G	Gate Resistance	$V_{GS}=0V, V_{DS}=0V, F=1MHz$		0.7		Ω
C_{iss}	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=20V,$ Frequency=1.0MHz		1520		pF
C_{oss}	Output Capacitance			346		
C_{riss}	Reverse Transfer Capacitance			53		
$t_{d(ON)}$	Turn-on Delay Time			9		
t_r	Turn-on Rise Time	$V_{DD}=20V, I_{DS}=40A,$ $V_{GEN}=10V, R_G=4.7\Omega$		80		
$t_{d(OFF)}$	Turn-off Delay Time			19		
t_f	Turn-off Fall Time			3		
Gate Charge Characteristics ⑥						
Q_g	Total Gate Charge	$V_{DS}=32V, V_{GS}=10V,$ $I_{DS}=40A$		25		nC
Q_{gs}	Gate-Source Charge			7		
Q_{gd}	Gate-Drain Charge			3		

Notes:

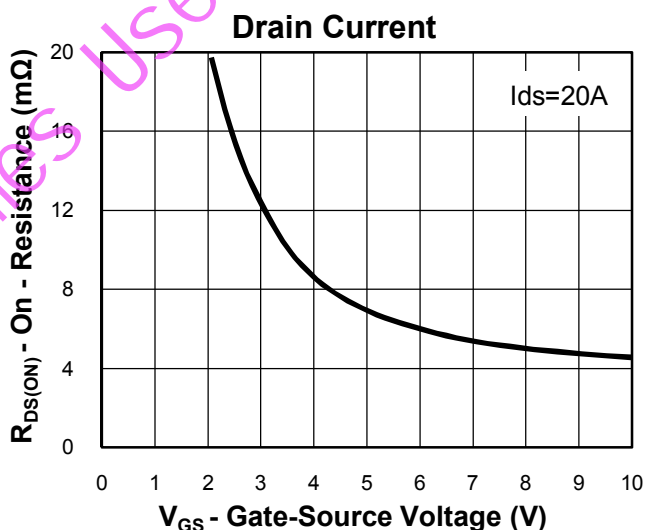
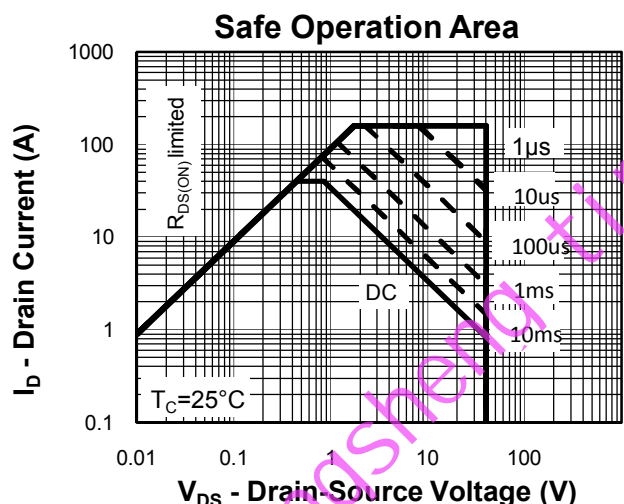
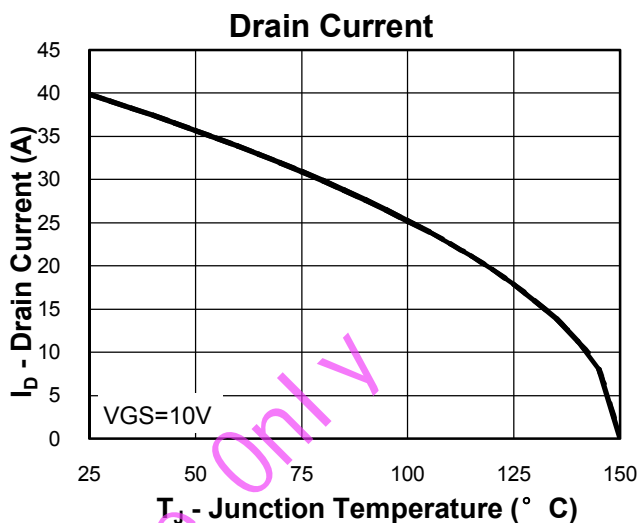
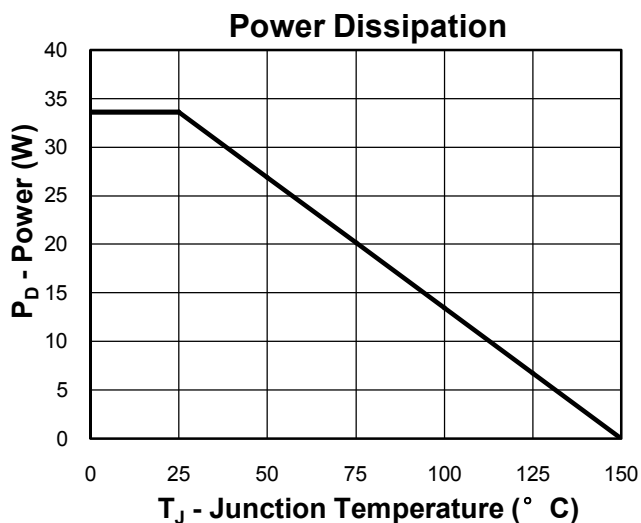
- ① Max current is limited by the source bonding.
- ② Pulse width limited by safe operating area.
- ③ When mounted on 1 inch square copper board, t 10sec.
- ④ Limited by TJmax, IAS =13A, VDD =32V, RG = 50Ω , Starting TJ = 25° C.
- ⑤ Pulse test ; Pulse width300s, duty cycle2%.
- ⑥ Guaranteed by design, not subject to production testing.

Ordering and Marking Information

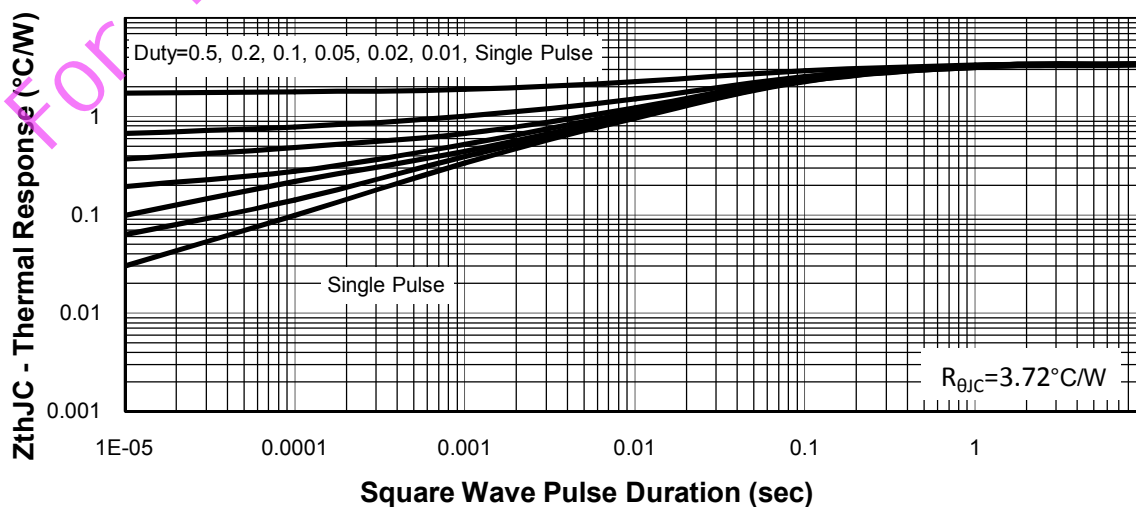
Device	Marking	Package	Packaging	Quantity	Reel Size	Tape width
RUH4040M2	RUH4040	DFN3030	Tape&Reel	5000	13"	12mm

For Tongsheng times Use Only

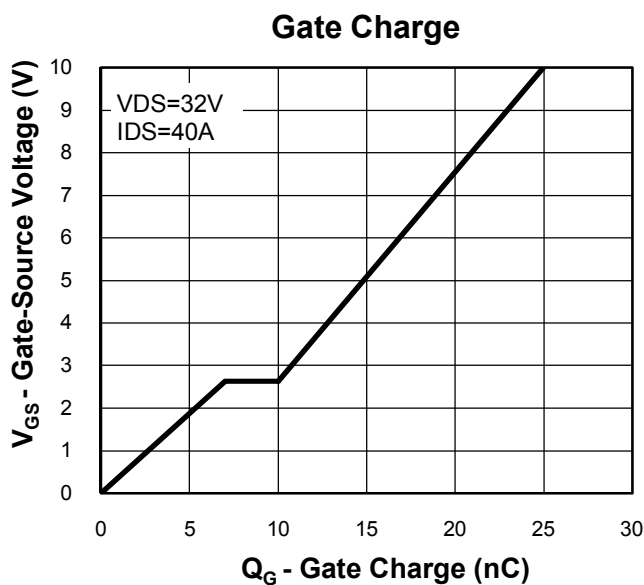
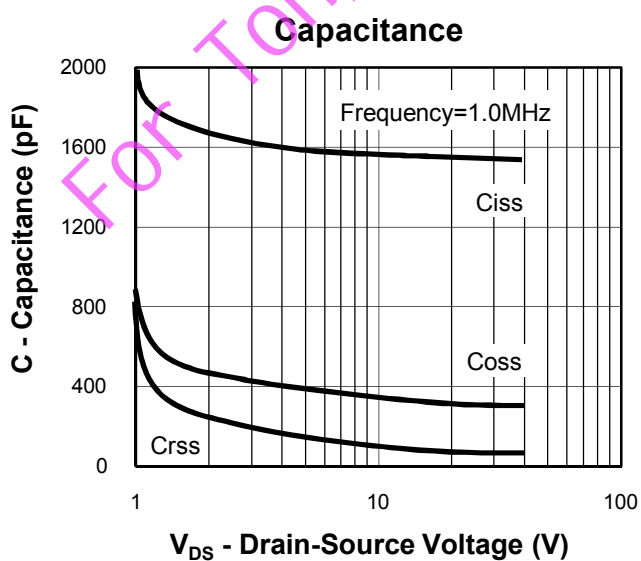
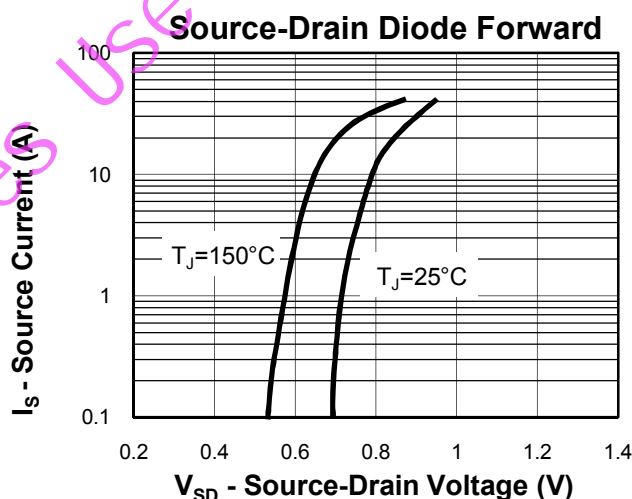
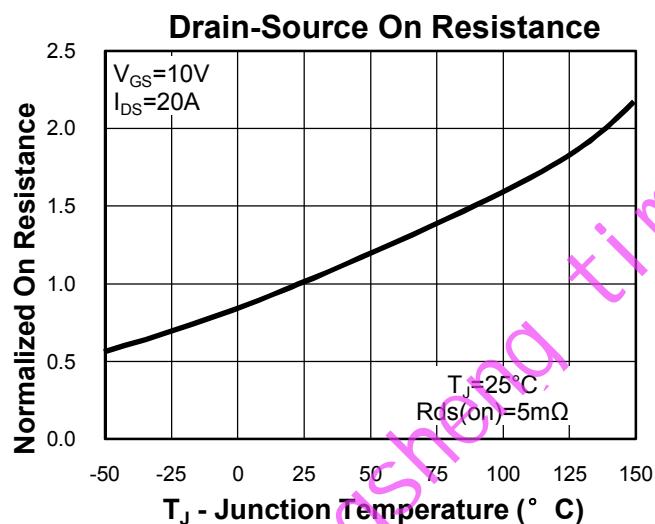
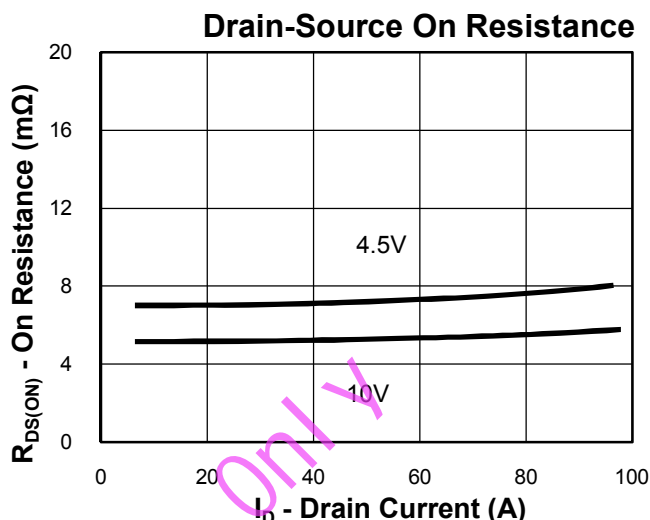
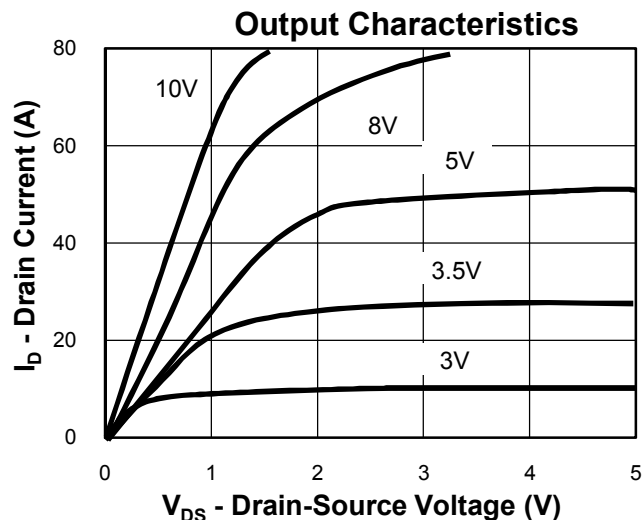
Typical Characteristics



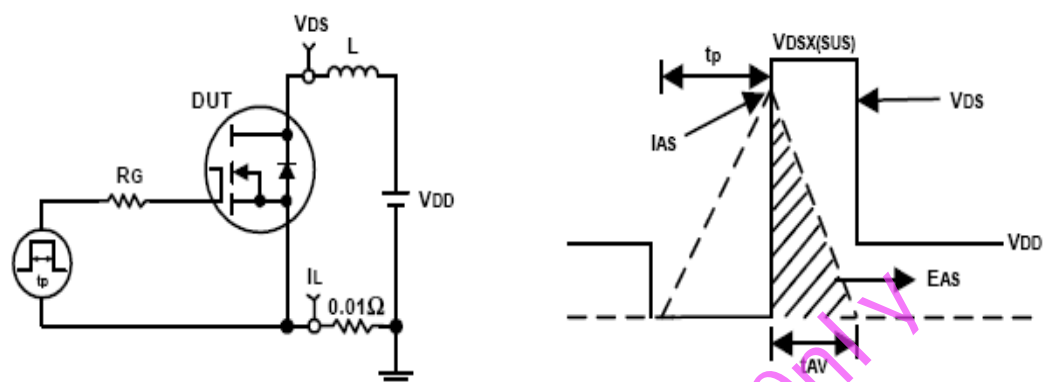
Thermal Transient Impedance



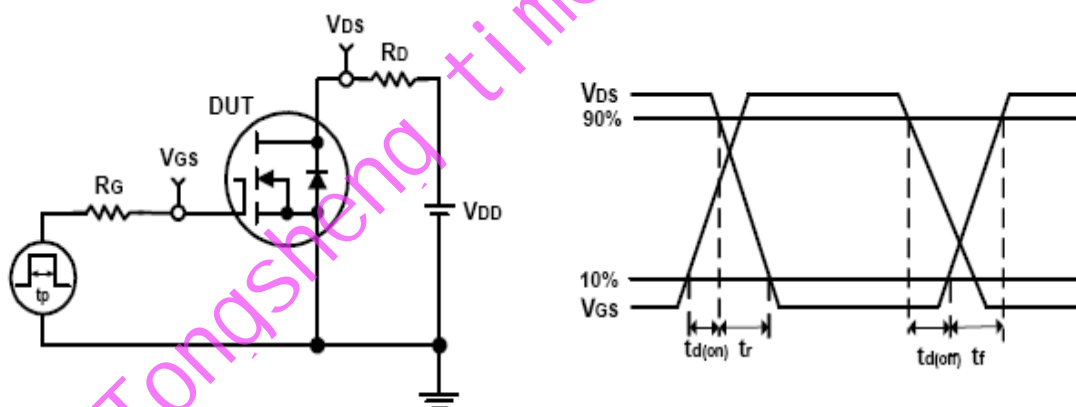
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Avalanche Test Circuit and Waveforms

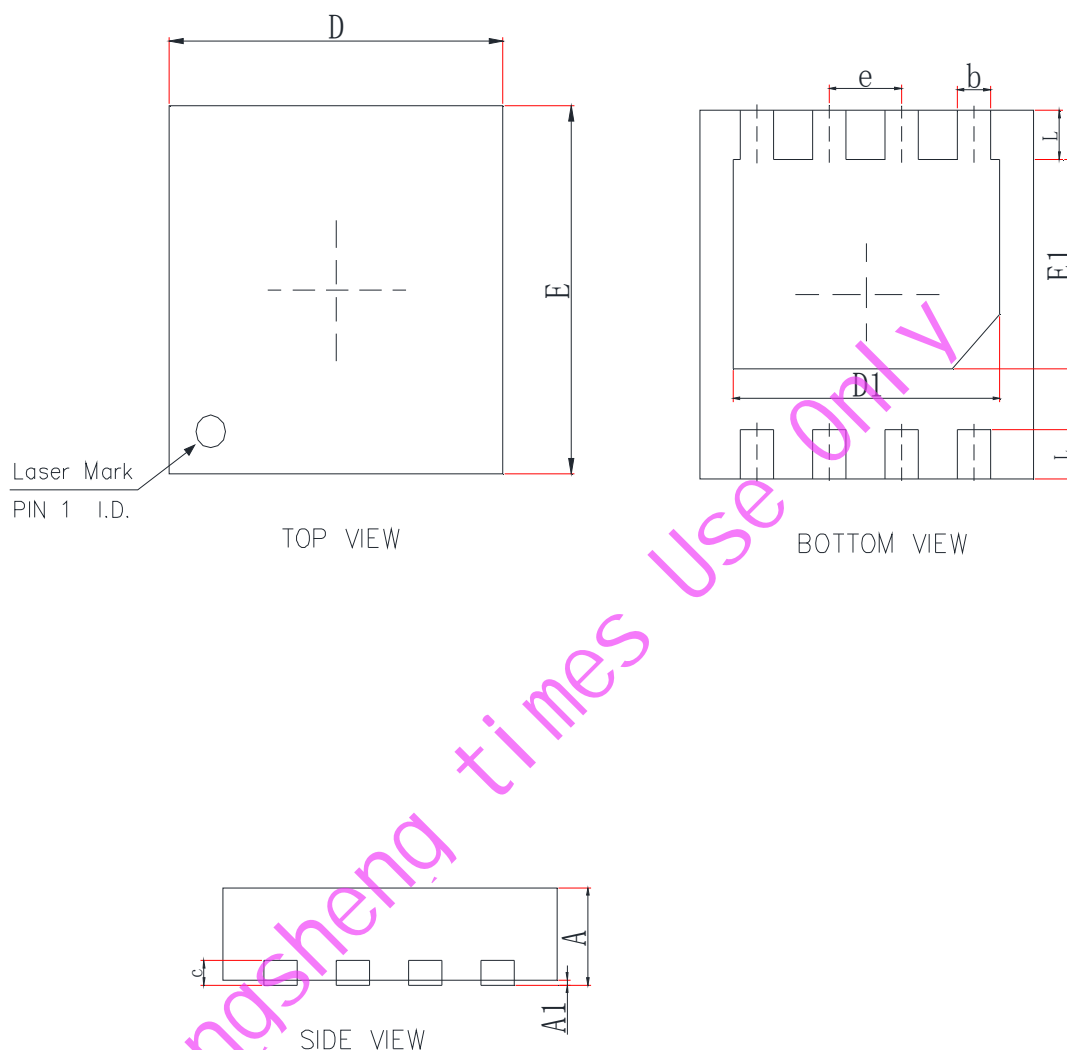


Switching Time Test Circuit and Waveforms



Package Information

DFN3030



SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.70	0.75	0.80	0.028	0.030	0.031
A1			0.05			0.002
b	0.25	0.30	0.35	0.010	0.012	0.014
c	0.18	0.20	0.30	0.007	0.008	0.012
D	2.95	3.00	3.15	0.116	0.118	0.124
E	2.95	3.00	3.15	0.116	0.118	0.124
D1	2.30	2.40	2.50	0.091	0.094	0.098
E1	1.70	1.80	1.90	0.067	0.071	0.075
L	0.30	0.40	0.50	0.012	0.016	0.020
e	0.65 BSC			0.026 BSC		